

The 14th International Conference on Advanced Materials and Devices

ICAMD 2025

December 8–12, 2025 | BEXCO, BUSAN, KOREA

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- Ferroelectric Photonics Laboratory

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December 10 (Wed), 2025

Poster Session 3

18:15~20:15

1F & 2F Lobby

Materials and Devices for Advanced CMOS Technology

WED-MA25-208 Work function modulation of electrodes inducing self-rectification in HfZrO₂-based FTJ for crossbar array

Hyeon Jin Ahn, Jung Ho Yoon
(Sungkyunkwan University)

WED-MA25-267 Emergence of ferroelectricity in annealing-free Hf_{0.5}Zr_{0.5}O₂ with MoO₃ interlayer driving oxygen ion migration

Moonseek Jeong, Min Hyuk Park, Geun Hyeong Park, Dong Hee Han, Taegyu Kwon, Yong Hyeon Cho, Dong In Han
(Department of Materials Science and Engineering, College of Engineering, Seoul National University)

WED-MA25-324 Enhanced NiSi formation via template effect and suppression of Ni channeling by employing Mo₂N interlayer

Jiwan Hong, Seoeun Yoon, Woojin Jeon
(Kyung Hee University)

WED-MA25-335 Suppressing residual Cl-induced defect from TiCl₄-based ALD TiN into ZrO₂ by introducing an In₂O₃ capping layer for MIM capacitors

Hunseok Son, Seoeun Yoon, Seungwoo Lee, Soo Min Yoo, Woojin Jeon
(Kyung Hee University)

WED-MA25-443 Switching Dynamics of MIS, MFM, and MFMIS Capacitors under Pulsed Voltage Operation

Minu Kang, Cheol Jun Kim, Teahee Noh, Hyeon Su Seong, Seung Jin Kang, Bo Soo Kang
(Hanyang university)

WED-MA25-470 Optoelectronic Charge Trap Memtransistor for Vision Explainable Artificial Intelligence Hardware

Min Gu Lee, Kyung Min Kim
(Korea Advanced Institute of Science and Technology)

WED-MA25-524 Development of Si-Photonics IP Bank and Monolithic Coherent Optical Transmitter for Energy-Efficient Interconnects

Kangyeob Park*, Hyun-Do Jung**, Junhyeok Seo*, Wonseok Oh*
(*Korea Electronics Technology Institute, **OE Solutions, Co., Ltd.)

WED-MA25-539 MoS₂ Channel-based Charge Trap Flash Memory with Optimized Sensing Methodologies for In-Memory Computing

Ki Han Kim*, Ju Han Park*, Khang June Lee**, Ji-Won Seo***, Yeong Kwon Kim*, Junhwan Choi****, Min-Jae Seo***, Byung Chul Jang*

(*Kyungpook National University, **The University of Suwon, ***University of Seoul, ****Dankook University)

WED-MA25-558 High-Speed 64-GBd PAM4 Driver with Passive On-Chip Coplanar Waveguide Equalizer Integrated with MZI-Based Optical Modulator

Junhyeok Seo*, Kangyeob Park**, Wonseok Oh**, Woo-Young Choi*

(*Yonsei University, **Korea Electronics Technology Institute)

WED-MA25-586 Large-Area Application of Nanocrystalline Ni-Co-Fe Alloy-Carbon Composite for Electromagnetic Interference Shielding

Jihun Lee, Joohoon Kang

(Yonsei University)

WED-MA25-589 Two-dimensional template-assisted conversion for ultrathin indium oxide-based single-gate reconfigurable transistors

Jinhong Min*, Myeongjin Jung**, Joohoon Kang*

(*Yonsei university, **Sungkyunkwan University)

WED-MA25-602 Symmetry-guided property optimization of Pca2_1 Hf-based fluorite ferroelectrics

Jinhyeong Jo*, Pawan Kumar**, Chang Hun Kim**, Jun Hee Lee**

(*Korea Institute of Science and Technology, **Ulsan National Institute of Science and Technology)

WED-MA25-612 Interfacial Defect Control of ZrO₂/TiN-Based DRAM Capacitors Using TiO₂ Buffer Layer

Hyeongjun Kim, Seungmin Jo, Woongkyu Lee

(Soongsil University)

WED-MA25-614 Atomic Layer Etching of ZrO₂ Using SF₆ Plasma and TiCl₄ for DRAM Capacitors

Juhyeong Kim, Sangyeon Jeong, Woongkyu Lee

(Soongsil University)

WED-MA25-616 Enhanced Switching Uniformity in HfO₂-Based RRAM via Control of TiN Deposition and TiO_xN_y Formation

Seokho Cho, Juan Hong, Woongkyu Lee

(Soongsil University)

High-Speed 64-GBd PAM4 Driver with Passive On-Chip Coplanar Waveguide Equalizer Integrated with MZI-Based Optical Modulator

Junhyeok Seo^{1,*}, Kangyeob Park², Wonseok Oh², and Woo-Young Choi^{1,**}

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This paper presents the design and integration of a high-speed 64-GBd four-level pulse amplitude modulation (PAM4) driver co-optimized with a Mach–Zehnder interferometer (MZI)-based optical modulator for next-generation optical interconnects. The proposed driver architecture employs a passive feed-forward equalizer (FFE) realized with on-chip coplanar waveguides (CPWs), which function as tunable delay elements. This approach eliminates the need for clocked equalization circuits, enabling fully asynchronous operation across a wide frequency range from DC to the 3-dB bandwidth limit of 55 GHz. The driver incorporates a high-swing transconductance (G_m) cell enhanced by an external gate impedance network, thereby ensuring improved linearity and sufficient modulation depth required for high-order PAM4 signaling. The integrated silicon MZI modulator, fabricated with 2-mm-long upper and lower arms, achieves an electro-optical (E-O) bandwidth of 35 GHz and an extinction ratio exceeding 6 dB. Post-layout simulation results confirm high-speed operations at 64-GBd PAM4 signals with a 3-V_{pp} differential output swing, achieving an eye opening of 0.55 UI with minimized inter-symbol interference (ISI) and a bit-error rate of 2.4×10^{-4} after modeled fiber transmission. The effect of CPW-based passive equalization and MZI integration enables superior bandwidth extension, reduced energy consumption, and enhanced scalability. The proposed driver can be applied in next-generation optical interconnect systems with low-power, high-capacity, high-linearity capabilities.

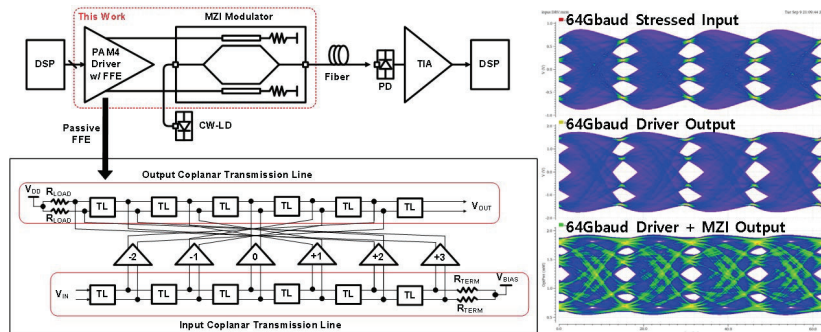


Fig 1. Proposed 64Gbaud PAM4 driver and post-layout simulation results

* This work was supported by the R&D Program (Project No. RS-2025-02304291 and RS-2024-00344688) funded by the Ministry of Science and ICT (MSIT, Korea).